NXPSC08650D

Silicon Carbide Diode

Rev.02 - 04 November 2019

Product data sheet

1. General description

WeEn Sem

Silicon Carbide Schottky diode designed for high frequency switched mode power supplies in a TO252 (DPAK) plastic package.



2. Features and benefits

- Highly stable switching performance •
- High forward surge capability I_{FSM} •
- Extremely fast reverse recovery time .
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- **RoHS** compliant •

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- . PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Values			Unit	
Absolute	maximum rating						
V _{RRM}	repetitive peak reverse voltage		650			V	
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 119 °C; Fig. 1; Fig. 2; Fig. 3		8		A	
T_{j}	junction temperature		175		°C		
Symbol	Parameter	Conditions	Min Typ Max		Unit		
Static ch	aracteristics						
V _F	forward voltage	I _F = 8 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.5	1.7	V
		I _F = 8 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.8	2.1	V
Dynamic	characteristics				,		
Q _r	recovered charge	I _F = 8 A; dI _F /dt = 500 A/μs; V _R = 400 V; T _j = 25 °C; <u>Fig. 7</u>		-	13	-	nC

5. Pinning information

Table 2. P	Table 2. Pinning information								
Pin	Symbol	Description	Simplified outline	Graphic symbol					
1	n.c.	not connected	· · · · · · · · · · · · · · · · · · ·						
2	К	cathode [1]		K <u>– K</u> 001aaa020					
3	А	anode							
mb	К	mounting base; connected to cathode							

[1] It is not possible to connect to pin 2 of the TO252 package.

6. Ordering information

Та	Table 3. Ordering information								
Т	ype number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
٨	XPSC08650D	TO252	NXPSC08650D6J	Reel	2500	TO252NS	14-Nov-2016		

7. Marking

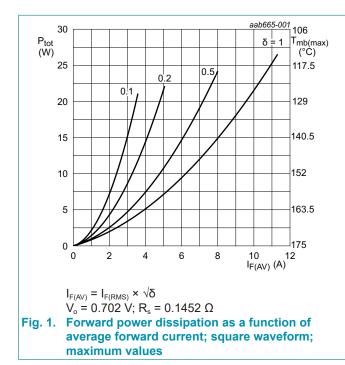
Table 4. Marking codes					
Type number	Marking codes				
NXPSC08650D	NXPSC				
	08650D				

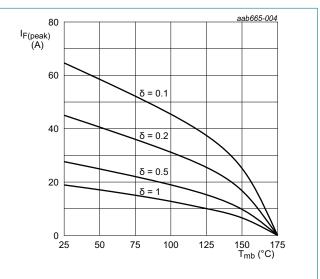
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

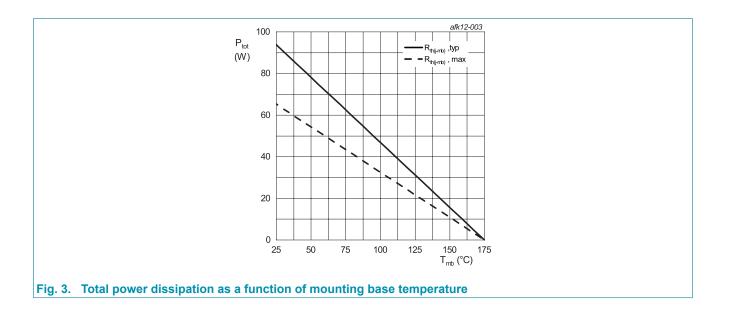
Symbol	Parameter	Conditions	Values	Unit
V _{RRM}	repetitive peak reverse voltage		650	V
V_{RWM}	crest working reverse voltage		650	V
V _R	reverse voltage	DC	650	V
$I_{\rm F(AV)}$	average forward current	δ = 0.5; square-wave pulse; T _{mb} ≤ 119 °C; Fig. 1; Fig. 2; Fig. 3	8	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 µs; square-wave pulse	16	A
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	48	А
	forward current	t_p = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse	385	А
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; t_p = 10 ms	11.5	A ² s
T _{stg}	storage temperature		-55 to 175	°C
T _j	junction temperature		175	°C





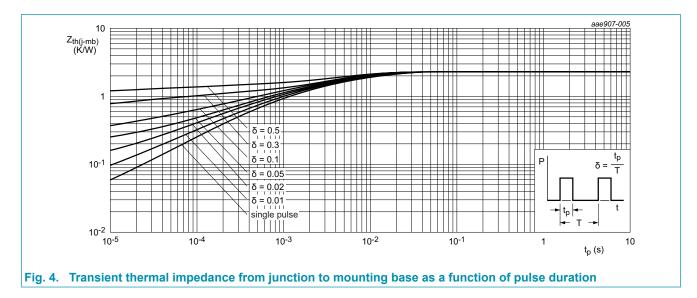


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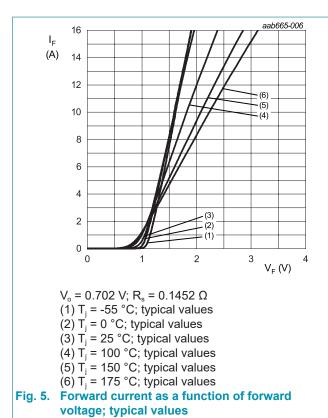
9. Thermal characteristics

Table 6. Th	ermal characteristics		 			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	with heatsink compound; Fig. 4	-	1.6	2.3	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air	-	50	-	K/W



10. Characteristics

	haracteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V _F	forward current	I _F = 8 A; T _j = 25 °C; <u>Fig. 5</u>	-	1.5	1.7	V
		I _F = 8 A; T _j = 150 °C; <u>Fig. 5</u>	-	1.8	2.1	V
I _R	reverse current	V _R = 650 V; T _j = 25 °C; <u>Fig. 6</u>	-	-	50	μA
		V _R = 650 V; T _j = 150 °C; <u>Fig. 6</u>	-	-	200	μA
Dynamic	characteristics	· · · ·	I			
Q _r	recovered charge	I _F = 8 A; V _R = 400 V; dI _F /dt = 500 A/μs; T _j = 25 °C; <u>Fig. 7</u>	-	13	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C	-	267	-	pF
		f = 1 MHz; V _R = 300 V; T _j = 25 °C	-	37	-	pF
		f = 1 MHz; V _R = 600 V; T _j = 25 °C	-	36	-	pF
E _{as}	non-repetitive	I _R = 4.9 A; L = 5 mH; T _{j(init)} = 25 °C	60	-	-	mJ
	avalanche energy					



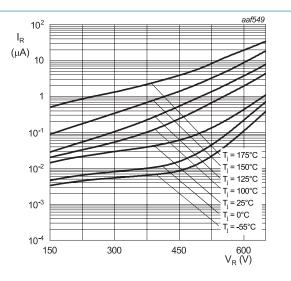
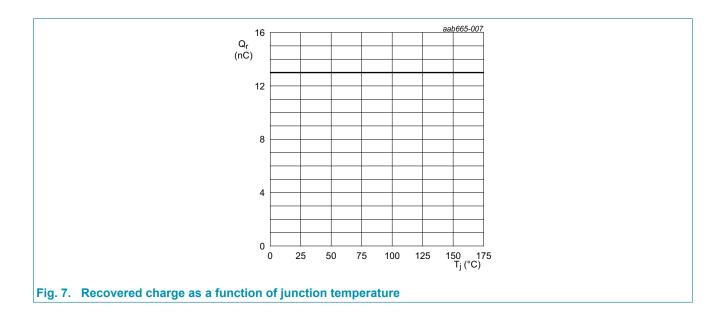
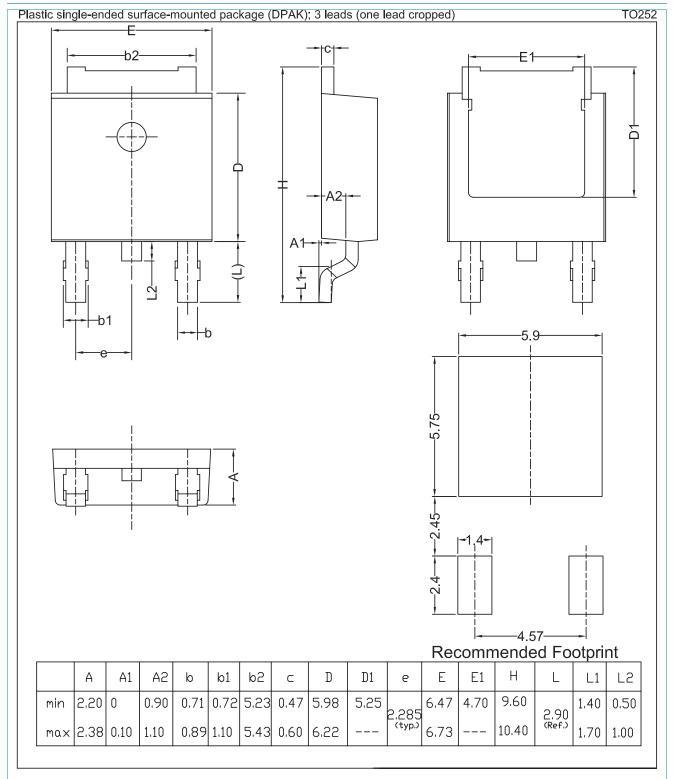


Fig. 6. Reverse leakage current as a function of reverse voltage; typical value

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11. Package outline



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12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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